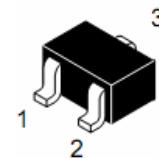


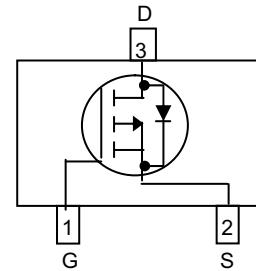
WPM3005
Single P-Channel, -30V, -4.1A, Power MOSFET

V_{DS} (V)	R_{ds(on)} (Ω)
-30	0.057@ V _{GS} = - 10.0V
	0.057@ V _{GS} = - 10.0V
	0.083@ V _{GS} = - 4.5V
	0.083@ V _{GS} = - 4.5V


SOT-23-3L

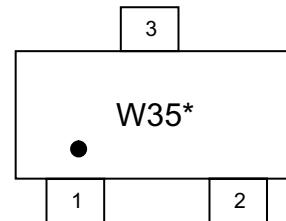
Descriptions

The WPM3005 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R_{DS (ON)} with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product WPM3005 is Pb-free.


Pin configuration (Top view)

Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package SOT-23-3L


 W35= Device Code
 * = Month (A~Z)

Marking

Applications

- Driver for Relay, Solenoid, Motor, LED etc.
- DC-DC converter circuit
- Power Switch
- Load Switch
- Charging

Order information

Device	Package	Shipping
WPM3005-3/TR	SOT-23-3L	3000/Reel&Tape

Absolute Maximum ratings

Parameter	Symbol	10 S	Steady State	Unit
Drain-Source Voltage	V _{DS}	-30		V
Gate-Source Voltage	V _{GS}	±20		
Continuous Drain Current ^a	T _A =25°C	I _D	-4.1	A
	T _A =70°C		-3.3	
Maximum Power Dissipation ^a	T _A =25°C	P _D	1.4	W
	T _A =70°C		0.9	
Continuous Drain Current ^b	T _A =25°C	I _D	-3.8	A
	T _A =70°C		-3.0	
Maximum Power Dissipation ^b	T _A =25°C	P _D	1.2	W
	T _A =70°C		0.8	
Pulsed Drain Current ^c	I _{DM}	-25		A
Operating Junction Temperature	T _J	150		°C
Lead Temperature	T _L	260		°C
Storage Temperature Range	T _{stg}	-55 to 150		°C

Thermal resistance ratings

Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	t ≤ 10 s	R _{θJA}	65	85
	Steady State		90	
Junction-to-Ambient Thermal Resistance ^b	t ≤ 10 s	R _{θJA}	85	100
	Steady State		115	
Junction-to-Case Thermal Resistance	R _{θJC}	40	60	

a Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper

b Surface mounted on FR4 board using minimum pad size, 1oz copper

c Repetitive rating, pulse width limited by junction temperature, t_p=10μs, Duty Cycle=1%

d Repetitive rating, pulse width limited by junction temperature T_J=150°C.



WPM3005

Electronics Characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0 V, I _D = -250uA	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -24 V, V _{GS} = 0V			-1	uA
Gate-to-source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = -250uA	-1.5	-2.0	-2.5	V
Drain-to-source On-resistance	R _{DS(on)}	V _{GS} = -10V, I _D = -4.1A		57	60	mΩ
		V _{GS} = -10V, I _D = -3.0A		57	60	
		V _{GS} = -4.5V, I _D = -4.0A		83	90	
		V _{GS} = -4.5V, I _D = -3.0A		83	90	
Forward Transconductance	g _{Fs}	V _{DS} = -5 V, I _D = -4.1A		7.6		S
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = -15 V		670		pF
Output Capacitance	C _{OSS}			75		
Reverse Transfer Capacitance	C _{RSS}			62		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = -10 V, V _{DS} = -15 V, I _D = -4.1 A		14.0		nC
Threshold Gate Charge	Q _{G(TH)}			1.31		
Gate-to-Source Charge	Q _{GS}			2.0		
Gate-to-Drain Charge	Q _{GD}			2.45		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	td(ON)	V _{GS} = -10 V, V _{DS} = -15V, R _L =5.0 Ω, R _G =15 Ω		6.8		ns
Rise Time	tr			3.2		
Turn-Off Delay Time	td(OFF)			25.2		
Fall Time	tf			4.4		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = -1.0A	-0.55	-0.78	-1.50	V